

**IN THE TITLE:**

On page 1, before the heading "BACKGROUND OF THE INVENTION," please add the following Title:

--WIRING TAPE FOR SEMICONDUCTOR DEVICE INCLUDING A BUFFER LAYER HAVING INTERCONNECTED FOAMS--

**IN THE SPECIFICATION:**

On page 1, after the "TITLE" and before the heading "BACKGROUND OF THE INVENTION," please insert the following heading and paragraph:

**--CROSS-REFERENCE TO RELATED APPLICATIONS:**

This is a Continuation application of Serial No. 10/134,364, filed April 30, 2002, which is a Divisional of parent application Serial No. 09/092,138, filed June 5, 1998, now U.S. Patent No. 6,433,440, the entire disclosure of which is hereby incorporated by reference.--